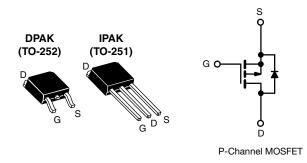


IRFR9010, IRFU9010, SiHFR9010, SiHFU9010

Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	-50				
R _{DS(on)} (Ω)	V _{GS} = -10 V 0.50				
Q _g (Max.) (nC)	9.1				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	5.9				
Configuration	Sing	le			

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche ratings
- Surface-mount (IRFR9010, SiHFR9010)
- Straight lead (IRFU9010, SiHFU9010)
- Simple drive requirements
- Ease of paralleling
- HALOGEN FREE

RoHS

COMPLIANT

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The power MOSFET technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance; superior reverse energy and diode recovery dV/dt capability.

The power MOSFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling and temperature stability of the electrical parameters.

Surface mount packages enhance circuit performance by reducing stray inductances and capacitance. The DPAK (TO-252) surface-mount package brings the advantages of power MOSFETs to high volume applications where PC Board surface mounting is desirable. The surface mount option IRFR9010, SiHFR9010 is provided on 16 mm tape. The straight lead option IRFU9010, SiHFU9010 of the device is called the IPAK (TO-251).

They are well suited for applications where limited heat dissipation is required such as, computers and peripherals, telecommunication equipment, DC/DC converters, and a wide range of consumer products.

Package DPAK (TO-2	52) DPAK (T	O-252) DPAK (TO-2	252) IPAK (TO-251)
Lead (Pb)-free and halogen-free SiHFR9010-0	GE3 SiHFR90	010TR-GE3 ^a SiHFR9010 ⁻	TRL-GE3 ^a SiHFU9010-GE3
Lead (Pb)-free IRFR9010Pb	F IRFR901	0TRPbF ^a IRFR9010TF	RLPbF ^a IRFU9010PbF

Note

a. See device orientation

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage	V _{DS}	-50	v		
Gate-source voltage	V _{GS}	± 20	v		
Continuous drain current	1	-5.3			
	$V_{GS} \text{ at -10 V} \qquad \begin{array}{c} T_C = 25 \text{ °C} \\ T_C = 100 \text{ °C} \end{array}$	T _C = 100 °C	I _D	-3.3	A
Pulsed drain current ^a	I _{DM}	-21			
Linear derating factor		0.20	W/°C		
Single pulse avalanche energy ^b	E _{AS}	136	mJ		
Drain-source voltage	I _{AR}	-5.3	А		
Maximum power dissipation $T_{C} = 25 \text{ °C}$			E _{AR}	2.5	mJ
Maximum power dissipation (PCB mount) e	PD	25	W		
Peak diode recovery dV/dt ^c	dV/dt	5.8	V/ns		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	- °C	
Soldering recommendations (peak temperature) ^d	For	10 s	-	300	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 14)

b. $V_{DD} = -25$ V, starting $T_J = 25$ °C, L = 9.7 mH, $R_g = 25 \Omega$, peak $I_L = -5.3$ A c. $I_{SD} \le -5.3$ A, dl/dt ≤ -80 A/µs, $V_{DD} \le 40$ V, $T_J \le 150$ °C, suggested $R_g = 24 \Omega$

d. 0.063" (1.6 mm) from case

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1 For technical questions, contact: hvm@vishay.com Document Number: 91378



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	-	110		
Case-to-sink	R _{thCS}	-	1.7	-	°C/W	
Maximum junction-to-case (drain) ^a	R _{thJC}	-	-	5.0		

Note

a. Mounting pad must cover heatsink surface area

PARAMETER	SYMBOL	т	EST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _G	_S = 0 V, I _D = - 250 μA	- 50	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS}	_S = V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 20 \text{ V}$	-	-	± 500	nA
	I	V _{DS} =	max. rating, V _{GS} = 0 V	-	-	- 250	
Zero gate voltage drain current	IDSS	$V_{DS} = 0.8 \text{ x m}$	V_{DS} = 0.8 x max. rating, V_{GS} = 0 V, T_{J} = 125		-	- 1000	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 2.8 A ^b	-	0.35	0.5	Ω
Forward transconductance	g _{fs}	V _{DS}	\leq - 50 V, I _{DS} = - 2.8 A	1.1	1.7	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	240	-	
Output capacitance	C _{oss}		$V_{DS} = -25 V,$	-	160	-	pF
Reverse transfer capacitance	C _{rss}	f =	= 1.0 MHz, see fig. 9	-	30	-	
Total gate charge	Qg	$I_D = -4.7 \text{ A}, V_{DS} = 0.8 \text{ x max}.$		-	6.1	9.1	
Gate-source charge	Q _{gs}	$V_{GS} = -10 V$	rating, see fig. 16 (Independent operating	- 2.0	3.0	nC	
Gate-drain charge	Q _{gd}		temperature)	-	3.9	5.9	
Turn-on delay time	t _{d(on)}			-	6.1	9.2	
Rise time	t _r		$= -25 \text{ V}, \text{ I}_{\text{D}} = -4.7 \text{ A},$	-	47	71	
Turn-off delay time	t _{d(off)}		Ω , R _D = 5.6 Ω , see fig. 15 lent operating temperature)	-	13	20	ns
Fall time	t _f			-	35	59	
Internal drain inductance	L _D	6 mm (0.	Between lead, 6 mm (0.25") from		4.5	-	nH
Internal source inductance	L _S		nd center of	-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sy showing the	e (H)	-	-	- 5.3	А
Pulsed diode forward current ^a	I _{SM}	integral revo p - n junctio	₹ -+	-	-	- 18	
Body diode voltage	V _{SD}	T _J = 25 °	$^{\circ}$ C, I _S = - 5.3 A, V _{GS} = 0 V ^b	-	-	- 5.5	V
Body diode reverse recovery time	t _{rr}	T 25 °C	I _F = - 4,7 A, dl/dt = 100 A/µs ^b	33	75	160	ns
Body diode reverse recovery charge	Q _{rr}	1J=25 C,	$\mu_{\rm P} = -4,7$ A, $\alpha_{\rm P} \alpha_{\rm I} = 100$ A/ μ S ²	0.090	0.22	0.52	μC
Forward turn-on time	t _{on}	Intrinsic	turn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 14)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

2

VISHAY.

IRFR9010, IRFU9010, SiHFR9010, SiHFU9010

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

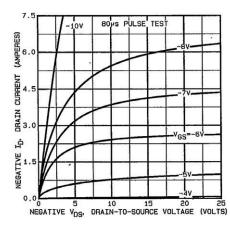


Fig. 1 - Typical Output Characteristics

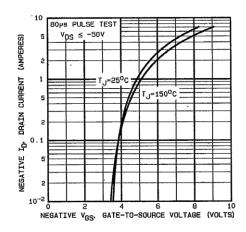


Fig. 1 - Typical Transfer Characteristics

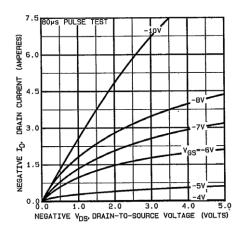


Fig. 2 - Typical Saturation Characteristics

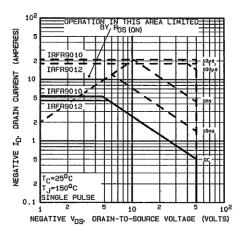


Fig. 3 - Maximum Safe Operating Area

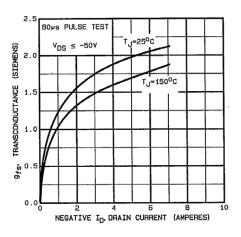


Fig. 4 - Typical Transconductance vs. Drain Current

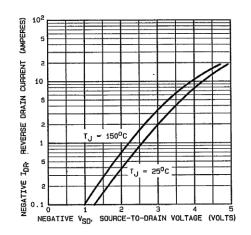


Fig. 5 - Typical Source-Drain Diode Forward Voltage

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IRFR9010, IRFU9010, SiHFR9010, SiHFU9010

ID

-4.7A

Qg.

(VOLTS)

VOLTAGE 10

GATE-TO-SOURCE

NEGATIVE V_{GS}.

5.0

4.0

з.0

2.0

1.0

0.0

PDS (an), DRAIN-TO-SOURCE ON RESISTANCE

PUI 10ú

(

Vishay Siliconix

-401

OR

ĥ

TOTAL GATE CHARGE (NC)

v_{DS} = . -25V

VDS

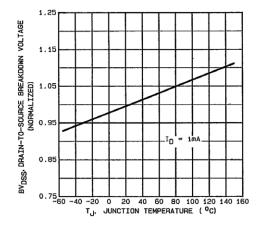


Fig. 6 - Breakdown Voltage vs. Temperature

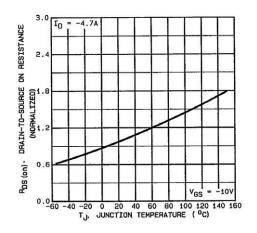


Fig. 7 - Normalized On-Resistance vs. Temperature

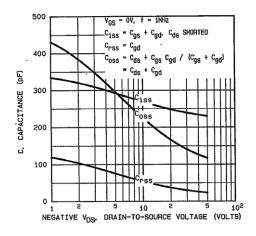
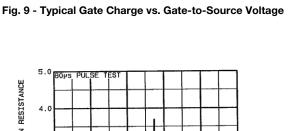


Fig. 8 - Typical Capacitance vs. Drain-to-Source Voltage

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16

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v_{gs}

12

DRAIN CURRENT (AMPERES)

TEST CIRCUIT

SEE FIGURE 16

8

10

Fig. 10 - Typical On-Resistance vs. Drain Current

GS

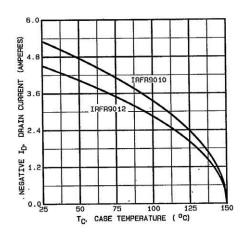
NEGATIVE ID.



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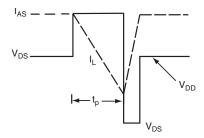


Fig. 13c - Unclamped Inductive Waveforms

Fig. 11 - Maximum Drain Current vs. Case Temperature

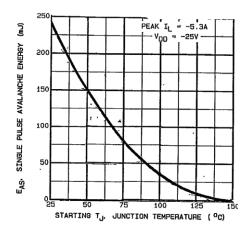


Fig. 2a - Maximum Avalanche vs. Starting Junction Temperature

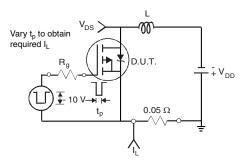


Fig. 13b - Unclamped Inductive Test Circuit

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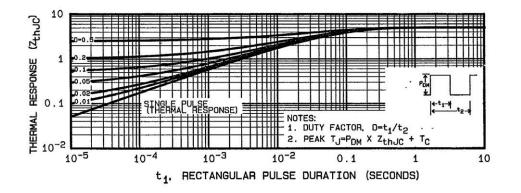


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration

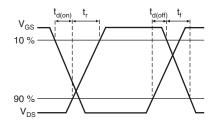


Fig. 14a - Switching Time Waveforms

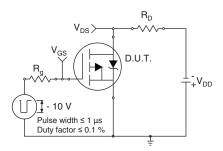


Fig. 15b - Switching Time Test Circuit

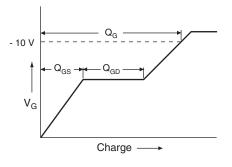


Fig. 16a - Basic Gate Charge Waveform

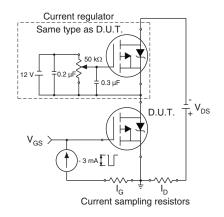


Fig. 16b - Gate Charge Test Circuit

6

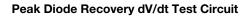
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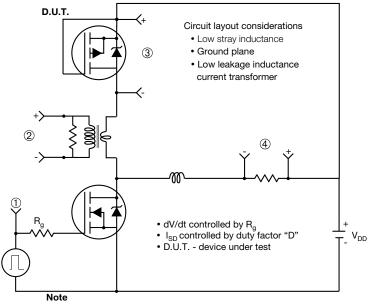
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• Compliment N-Channel of D.U.T. for driver

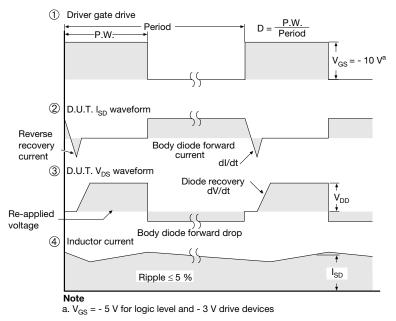


Fig. 17 - For P-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56 BSC			
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

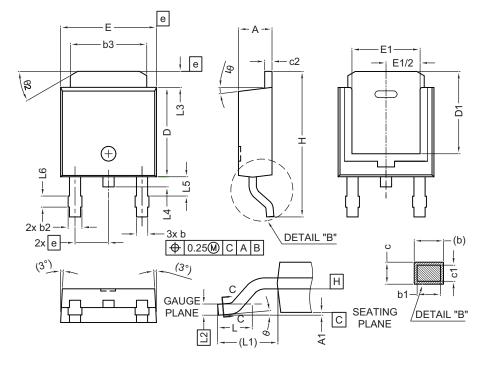
Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS				
DIM.	MIN.	MAX.			
A	2.18	2.39			
A1	-	0.13			
b	0.65	0.89			
b1	0.64	0.79			
b2	0.76	1.13			
b3	4.95	5.46			
С	0.46	0.61			
c1	0.41	0.56			
c2	0.46	0.60			
D	5.97	6.22			
D1	5.21	-			
E	6.35	6.73			
E1	4.32	-			
е	2.29	BSC			
Н	9.94	10.34			

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	l ref.		
L2	0.51	BSC		
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



Vishay Siliconix

TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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